

(0,80 mm) .0315"

# **BODY GROUND PLANE HEADER**

## **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?QRM8

Insulator Material: Black LCP Terminal & Ground Plane Material: Phosphor Bronze Plating: Au or Sn over 50μ" (1,27 μm) Ni Current Rating: Contact: 2.2 A per pin (1 pin powered per row) Ground: 8.5 A per ground plane (1 ground plane powered) Operating Temp Range:
-55°C to +125°C
Voltage Rating:
215 VAC

## Processing: Lead-Free Solderable:

RoHS Compliant:

Yes

SMT Lead Coplanarity:

(0,10 mm) .004" max (018-026) (0,15 mm) .006" max (036-078)

### RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



## **ALSO AVAILABLE** (MOQ Required)

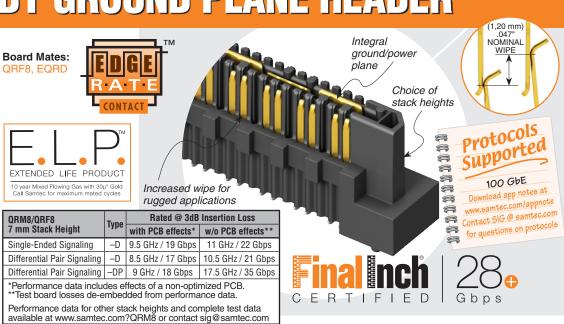
 Other platings Contact Samtec.

MATED HEIGHT*		
QRM8 LEAD STYLE	QRF8 LEAD STYLE	
	-05.0	-07.0
-02.0	(7,00) .276	(9,00) .354
-05.0	(10,00) .394	(12,00) .472
-07.0	(12,00) .472	(14,00) .551
*Processing conditions will		

Processing conditions will affect mated height.

Note: Patented

Note: Some lengths, styles and options are non-standard, non-returnable.



-026, -052, -078(52 total pins per bank = -D)

QRM8

PINS PER ROW

NO. OF PAIRS

-018, -036, -054(18 pairs per bank = -D-DP)

-02.0

**LEAD** 

STYLE

= 2 mm **Body Height** (Not available with -054 & -078 positions)

-05.0 = 5 mm **Body Height** 

-07.0 = 7 mm Body Height

= 10µ" (0,25 µm) Gold on contact,

Matte Tin

on tail

PLATING

**OPTION** 

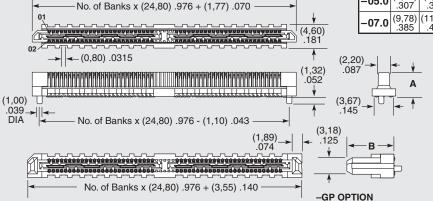
= Single Ended

**TYPE** 

-D-DP = Differential Pair

-D

#### LEAD В Α (4,81)(6,12)02.0 189 .241 (7.81)(9,12)-05.0.359 (9,78) (11,12) .385 .438 -07.0



## -GP

**OTHER** 

OPTION

= Guide Post (Requires -GP on mating connector)

## –K

(5,00 mm) .197" DIA Polyimide Film Pick & Place Pad

## -TR

=Tape & Reel (-018, -026, -036, -052 only)



## SAMTEC

- Edge Rate<sup>™</sup> contacts
- Increased contact
- 10 year MFG
- · Guide post option